

## OptiMOS<sup>®</sup> -P2 Power-Transistor



### Product Summary

$V_{DS}$	-30	V
$R_{DS(on)}$ (SMD Version)	10.8	m $\Omega$
$I_D$	-45	A

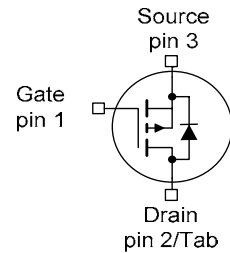
### Features

- P-channel - Logic Level - Enhancement mode
- AEC qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green Product (RoHS compliant)
- 100% Avalanche tested
- Intended for reverse battery protection

PG-TO263-3-2    PG-TO262-3-1    PG-TO220-3-1



Type	Package	Marking
IPB45P03P4L-11	PG-TO263-3-2	4P03L11
IPI45P03P4L-11	PG-TO262-3-1	4P03L11
IPP45P03P4L-11	PG-TO220-3-1	4P03L11



Maximum ratings, at  $T_j=25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	$I_D$	$T_C=25\text{ }^\circ\text{C}$ , $V_{GS}=-10\text{V}^{(1)}$	-45	A
		$T_C=100\text{ }^\circ\text{C}$ , $V_{GS}=-10\text{V}^{(2)}$	-42	
Pulsed drain current <sup>2)</sup>	$I_{D,pulse}$	$T_C=25\text{ }^\circ\text{C}$	-180	
Avalanche energy, single pulse	$E_{AS}$	$I_D=-22.5\text{A}$	110	mJ
Avalanche current, single pulse	$I_{AS}$	-	-45	A
Gate source voltage	$V_{GS}$	-	+5/-16	V
Power dissipation	$P_{tot}$	$T_C=25\text{ }^\circ\text{C}$	58	W
Operating and storage temperature	$T_j, T_{stg}$	-	-55 ... +175	$^\circ\text{C}$
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
<b>Thermal characteristics<sup>2)</sup></b>						
Thermal resistance, junction - case	$R_{thJC}$		-	-	2.6	K/W
Thermal resistance, junction - ambient, leaded	$R_{thJA}$		-	-	62	
SMD version, device on PCB	$R_{thJA}$	minimal footprint	-	-	62	
		6 cm <sup>2</sup> cooling area <sup>3)</sup>	-	-	40	

**Electrical characteristics, at  $T_j=25^\circ\text{C}$ , unless otherwise specified**

**Static characteristics**

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-1mA$	-30	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-85\mu A$	-1.0	-1.5	-2.0	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=-24V, V_{GS}=0V, T_j=25^\circ\text{C}$	-	-0.02	-1	$\mu A$
		$V_{DS}=-24V, V_{GS}=0V, T_j=125^\circ\text{C}^{2)}$	-	-7	-70	
Gate-source leakage current	$I_{GSS}$	$V_{GS}=-16V, V_{DS}=0V$	-	-	-100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-25A$	-	13.1	18.7	m $\Omega$
		$V_{GS}=-4.5V, I_D=-25A, \text{SMD version}$	-	12.8	18.4	
		$V_{GS}=-10V, I_D=-45A$	-	9.0	11.1	
		$V_{GS}=-10V, I_D=-45A, \text{SMD version}$	-	8.7	10.8	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

### Dynamic characteristics<sup>2)</sup>

Input capacitance	$C_{iss}$	$V_{GS}=0V, V_{DS}=-25V,$ $f=1MHz$	-	2900	3770	pF
Output capacitance	$C_{oss}$		-	835	1090	
Reverse transfer capacitance	$C_{rss}$		-	21	42	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=-15V,$ $V_{GS}=-10V, I_D=-45A,$ $R_G=3.5\Omega$	-	7	-	ns
Rise time	$t_r$		-	3	-	
Turn-off delay time	$t_{d(off)}$		-	45	-	
Fall time	$t_f$		-	14	-	

### Gate Charge Characteristics<sup>2)</sup>

Gate to source charge	$Q_{gs}$	$V_{DD}=-24V, I_D=-45A,$ $V_{GS}=0$ to $-10V$	-	11	14	nC
Gate to drain charge	$Q_{gd}$		-	5	10	
Gate charge total	$Q_g$		-	42	55	
Gate plateau voltage	$V_{plateau}$		-	-3.6	-	V

### Reverse Diode

Diode continuous forward current <sup>2)</sup>	$I_S$	$T_C=25^\circ C$	-	-	-45	A
Diode pulse current <sup>2)</sup>	$I_{S,pulse}$		-	-	-180	
Diode forward voltage	$V_{SD}$	$V_{GS}=0V, I_F=-45A,$ $T_j=25^\circ C$	-	-1.0	-1.3	V
Reverse recovery time <sup>2)</sup>	$t_{rr}$	$V_R=-15V, I_F=-45A,$ $di_F/dt=-100A/\mu s$	-	35	-	ns
Reverse recovery charge <sup>2)</sup>	$Q_{rr}$		-	26	-	nC

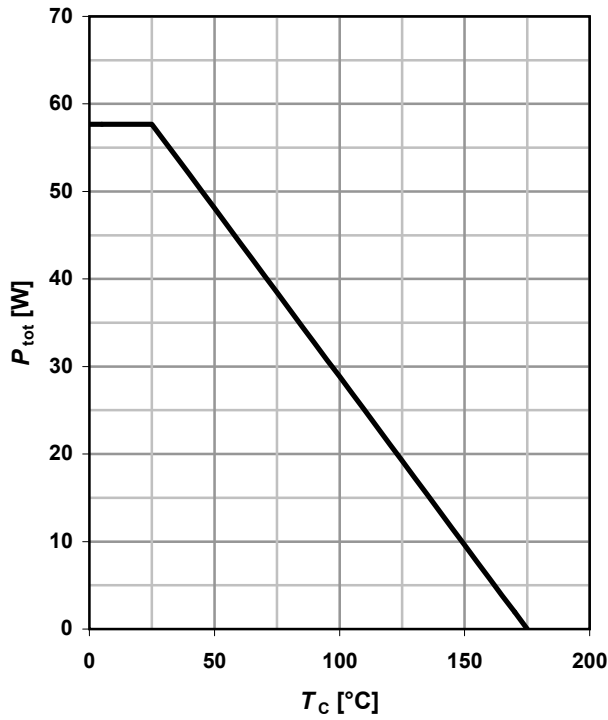
<sup>1)</sup> Current is limited by bondwire; with an  $R_{thJC} = 2.6K/W$  the chip is able to carry -A at 25°C.

<sup>2)</sup> Defined by design. Not subject to production test.

<sup>3)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

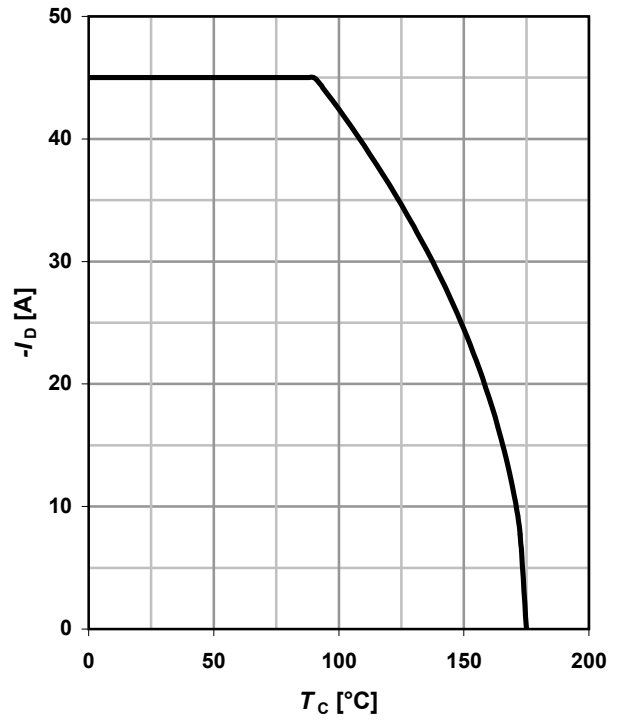
**1 Power dissipation**

$P_{tot} = f(T_C); V_{GS} \leq -6V$



**2 Drain current**

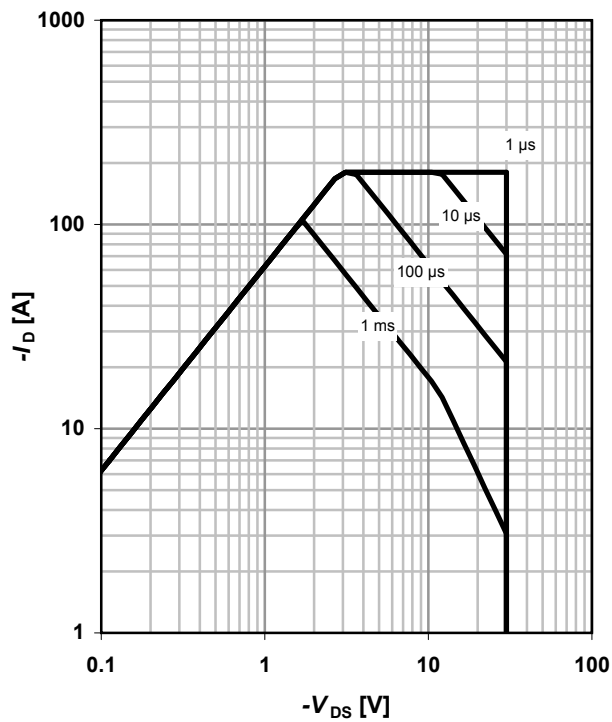
$I_D = f(T_C); V_{GS} \leq -6V; SMD$



**3 Safe operating area**

$I_D = f(V_{DS}); T_C = 25^\circ C; D = 0; SMD$

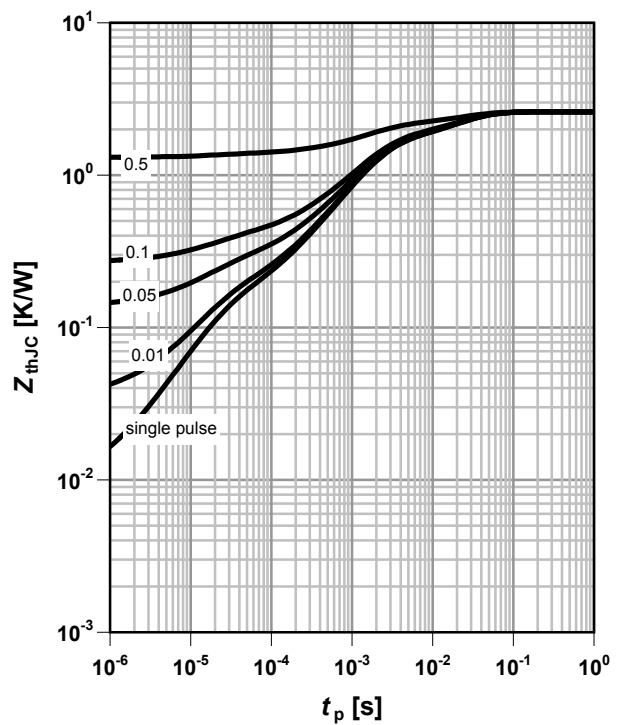
parameter:  $t_p$



**4 Max. transient thermal impedance**

$Z_{thJC} = f(t_p)$

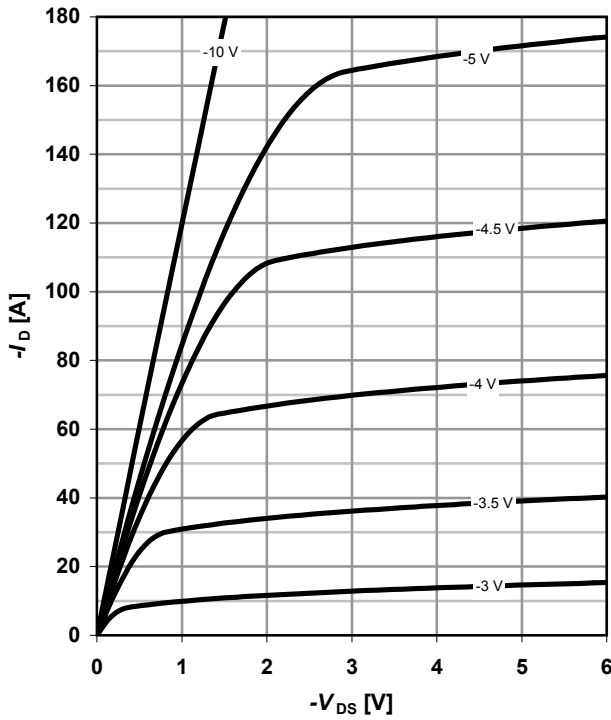
parameter:  $D = t_p/T$



**5 Typ. output characteristics**

$I_D = f(V_{DS}); T_j = 25^\circ\text{C}; \text{SMD}$

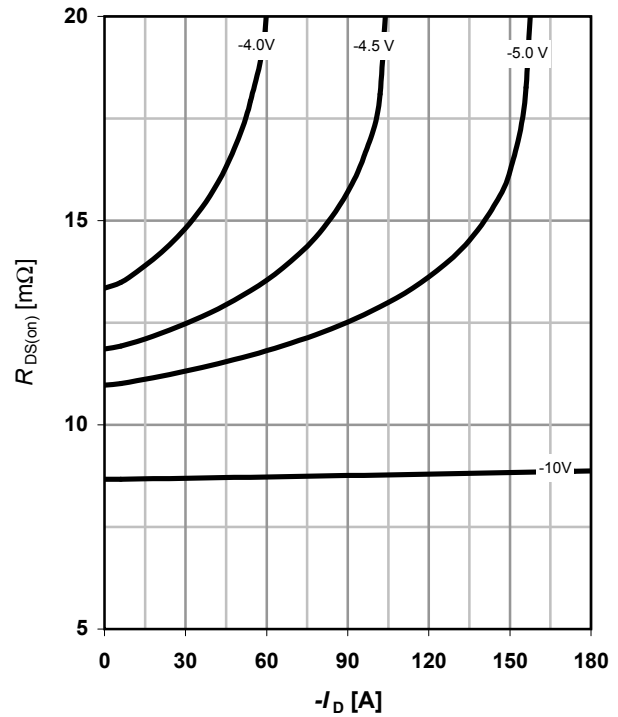
parameter:  $V_{GS}$



**6 Typ. drain-source on-state resistance**

$R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}; \text{SMD}$

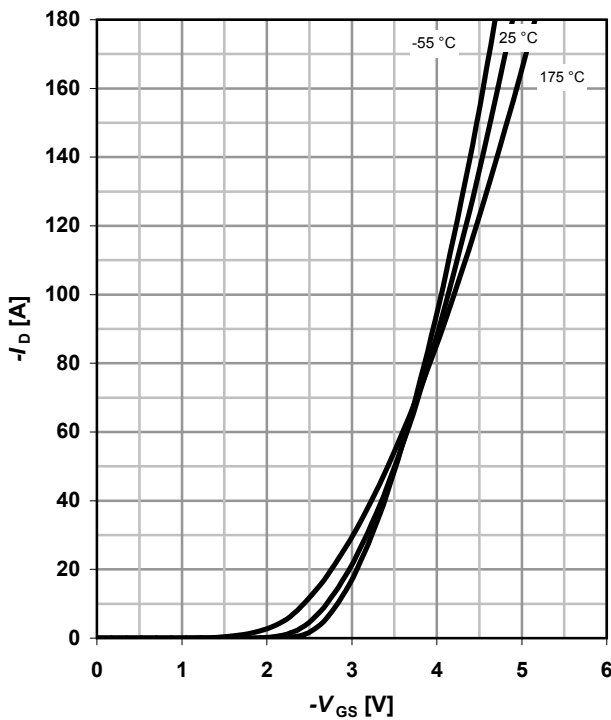
parameter:  $V_{GS}$



**7 Typ. transfer characteristics**

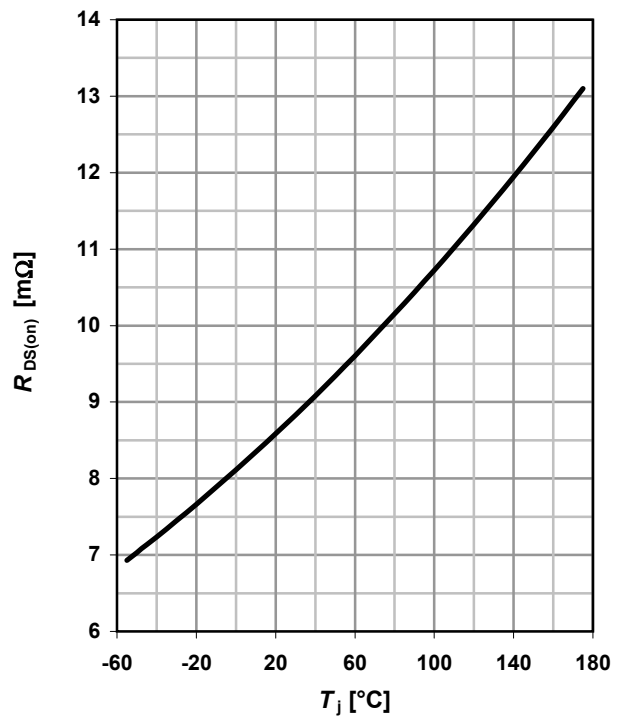
$I_D = f(V_{GS}); V_{DS} = -6V$

parameter:  $T_j$



**8 Typ. drain-source on-state resistance**

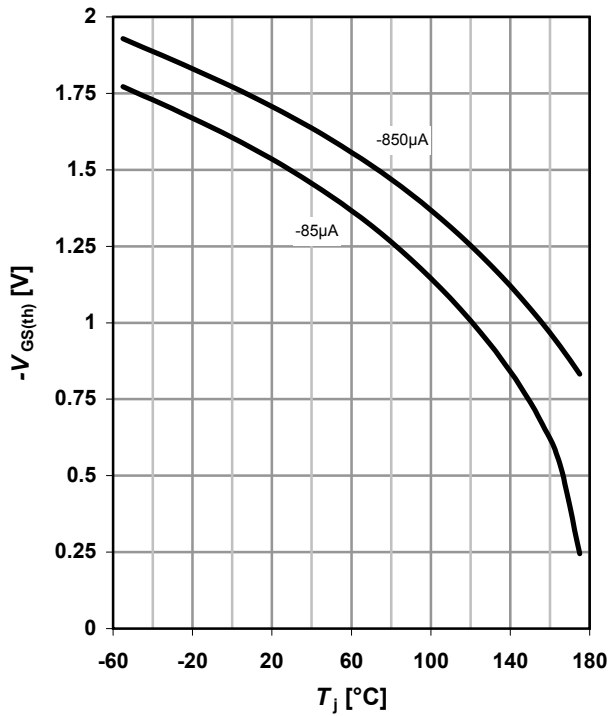
$R_{DS(on)} = f(T_j); I_D = -45A; V_{GS} = -10V; \text{SMD}$



**9 Typ. gate threshold voltage**

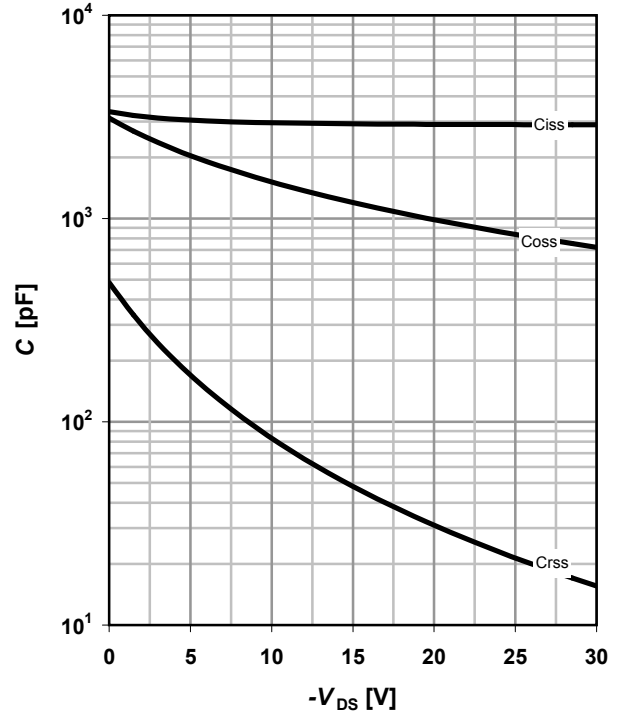
$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$

parameter:  $I_D$



**10 Typ. capacitances**

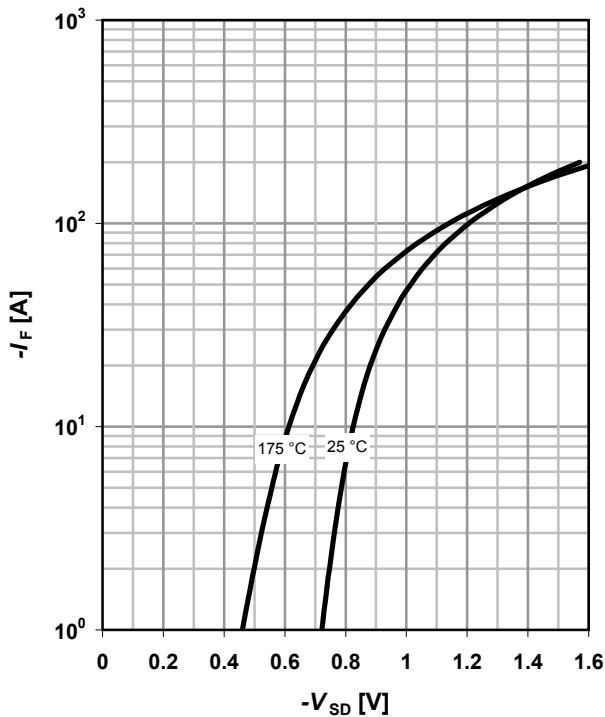
$C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$



**11 Typical forward diode characteristics**

$I_F = f(V_{SD})$

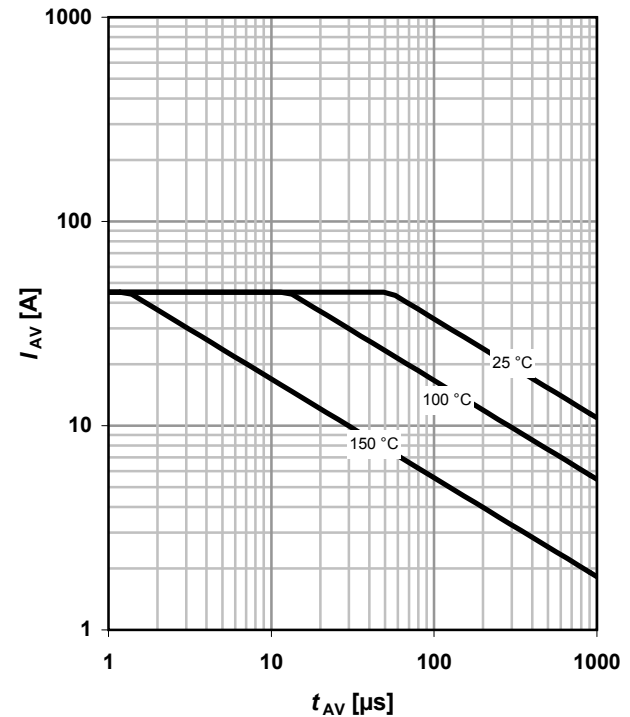
parameter:  $T_j$



**12 Avalanche characteristics**

$I_{AS} = f(t_{AV})$

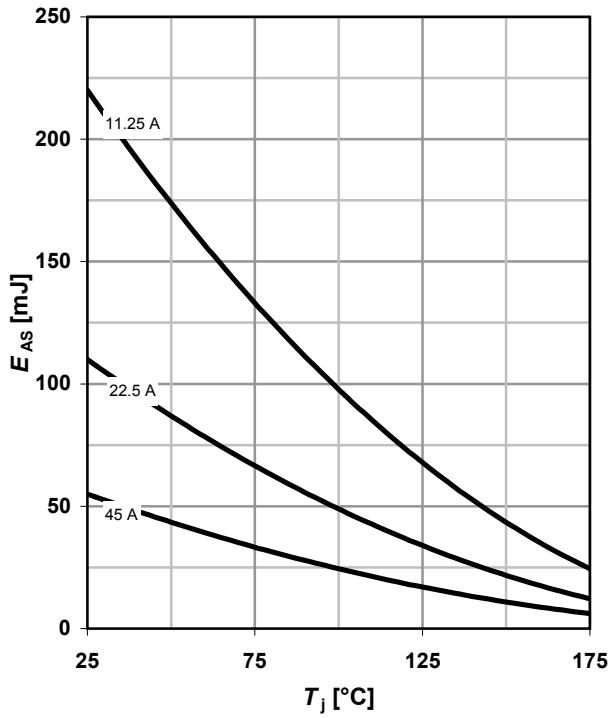
parameter:  $T_{j(start)}$



**13 Avalanche energy**

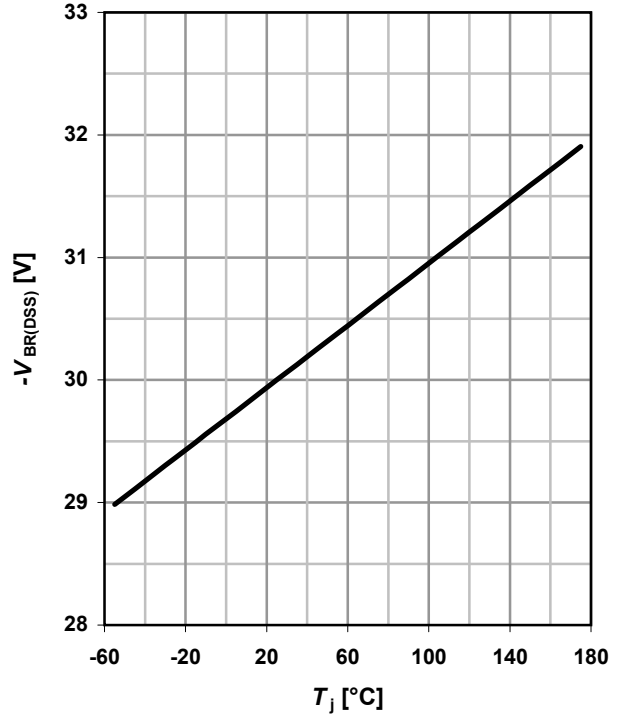
$$E_{AS} = f(T_j)$$

parameter:  $I_D$



**14 Drain-source breakdown voltage**

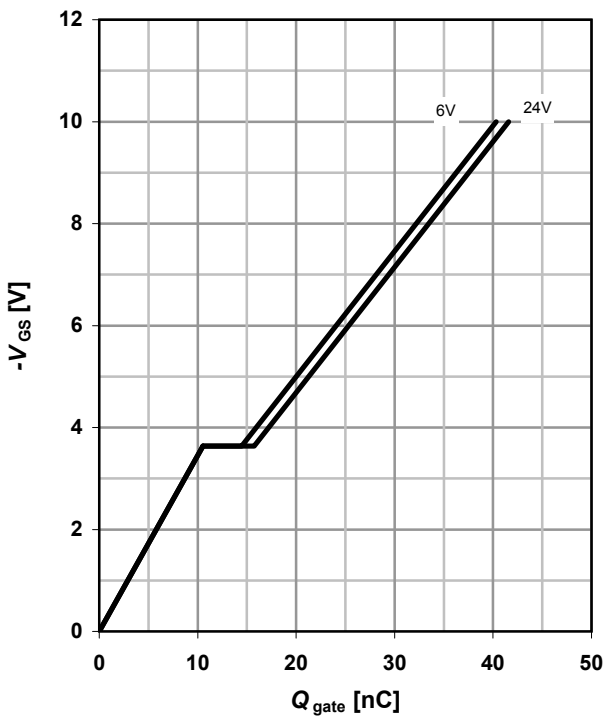
$$V_{BR(DSS)} = f(T_j); I_D = 1\text{mA}$$



**15 Typ. gate charge**

$$V_{GS} = f(Q_{gate}); I_D = -45\text{A pulsed}$$

parameter:  $V_{DD}$



**16 Gate charge waveforms**



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